Docket No.: 09852/0205608-US0

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Toshiyuki Nagase et al.

Application No.: National Phase of

PCT/JP2005/006618

Filed: Concurrently Herewith Art Unit: N/A

For: AI/AIN JOINT MATERIAL, BASE PLATE

FOR POWER MODULE, POWER MODULE, AND MANUFACTURING METHOD OF AI/AIN JOINT MATERIAL (AS AMENDED) Art Unit: N/A

Examiner: Not Yet Assigned

Confirmation No.: N/A

FIRST PRELIMINARY AMENDMENT

MS PCT Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

Prior to examination on the merits, please amend the above-identified U.S. patent application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 8 of this paper.